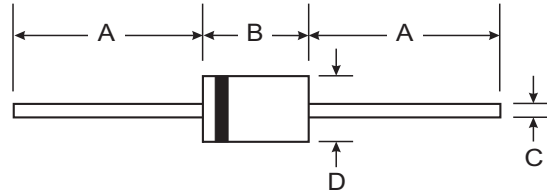


Features

- Epitaxial Construction
- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- High Surge Capability
- High Current Capability and Low Forward Voltage Drop
- Surge Overload Rating to 150A Peak
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Applications
- **Lead Free Finish, RoHS Compliant (Note 4)**



Mechanical Data

- Case: DO-201AD
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Finish — Bright Tin. Plated Leads Solderable per MIL-STD-202, Method 208
- Polarity: Cathode Band
- Mounting Position: Any
- Ordering Information: See Last Page
- Marking: Type Number
- Weight: 1.1 grams (approximate)

DO-201AD		
Dim	Min	Max
A	25.40	—
B	7.20	9.50
C	1.20	1.30
D	4.80	5.30
All Dimensions in mm		

Maximum Ratings and Electrical Characteristics @ T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

Characteristic	Symbol	SB520	SB530	SB540	SB550	SB560	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	20	30	40	50	60	V
RMS Reverse Voltage	V _{R(RMS)}	14	21	28	35	42	V
Average Rectified Output Current (See Figure 1) (Note 1)	I _O	5.0					A
Non-Repetitive Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}	150					A
Forward Voltage (Note 2) @ I _F = 5.0A	V _{FM}	0.55			0.67		V
Peak Reverse Current @ T _A = 25°C at Rated DC Blocking Voltage (Note 2) @ T _A = 100°C	I _{RM}	0.5			25		mA
Typical Thermal Resistance Junction to Ambient (Note 1) (Note 3)	R _{θJA}	25					°C/W
	R _{θJL}	8					
Operating Temperature Range	T _J	-65 to +125			-65 to +150		°C
Storage Temperature Range	T _{STG}	-65 to +150					

- Notes:
1. Measured at ambient temperature at a distance of 9.5mm from case.
 2. Short duration test pulse used to minimize self-heating effect.
 3. Thermal resistance junction to lead vertical P.C.B. mounted, 0.375" (9.5mm) lead length.
 4. RoHS revision 13.2.2003. Glass and High Temperature Solder Exemptions Applied, see *EU Directive Annex Notes 5 and 7*.

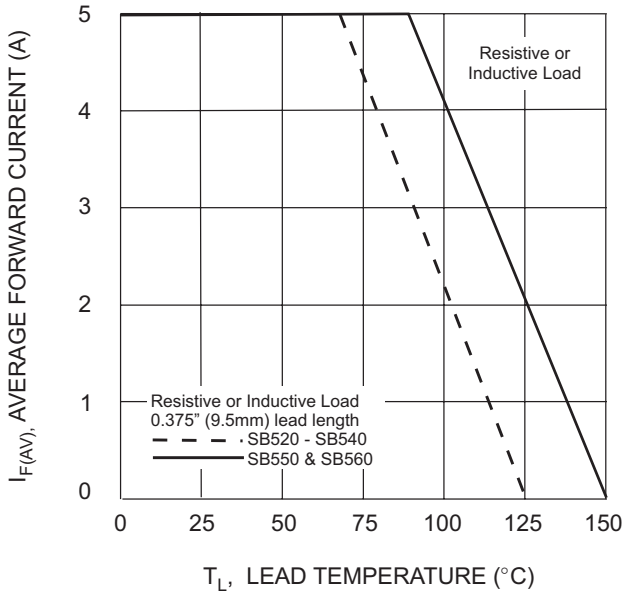


Fig. 1 Forward Current Derating Curve

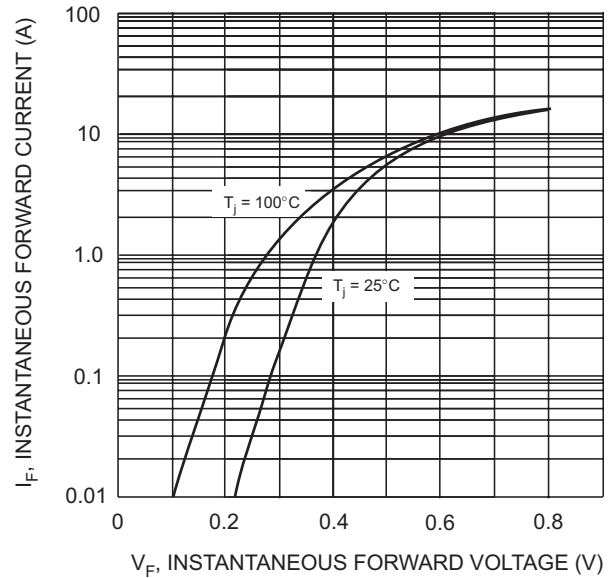


Fig. 2 Typical Forward Characteristics, SB520 - SB540

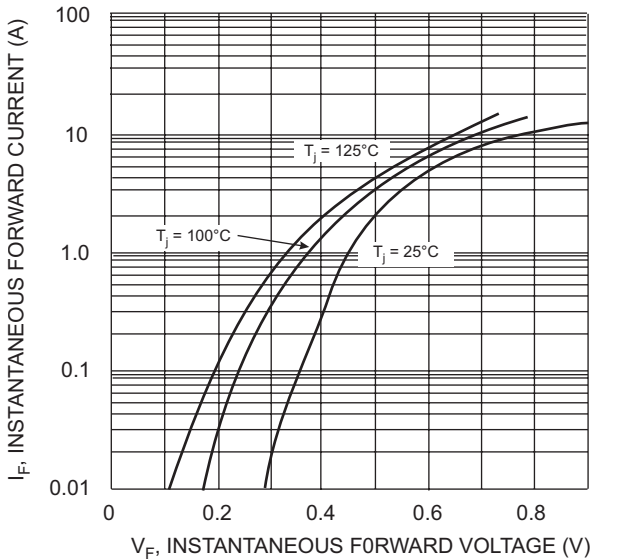


Fig. 3 Typical Forward Characteristics, SB550 & SB560

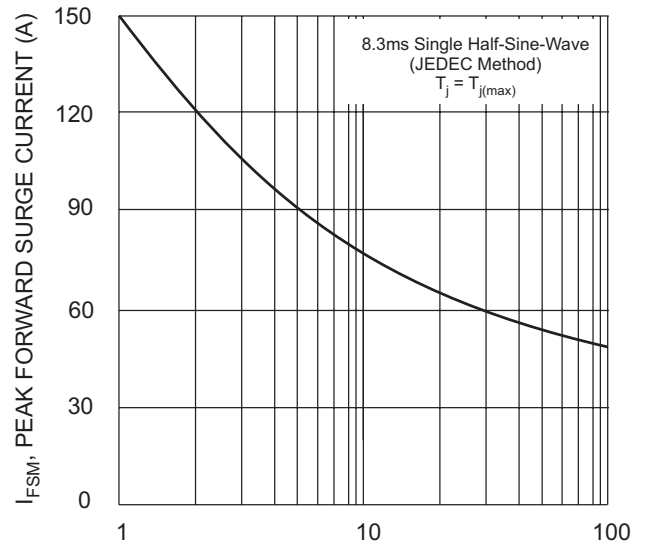


Fig. 4 Max Non-Repetitive Peak Fwd Surge Current

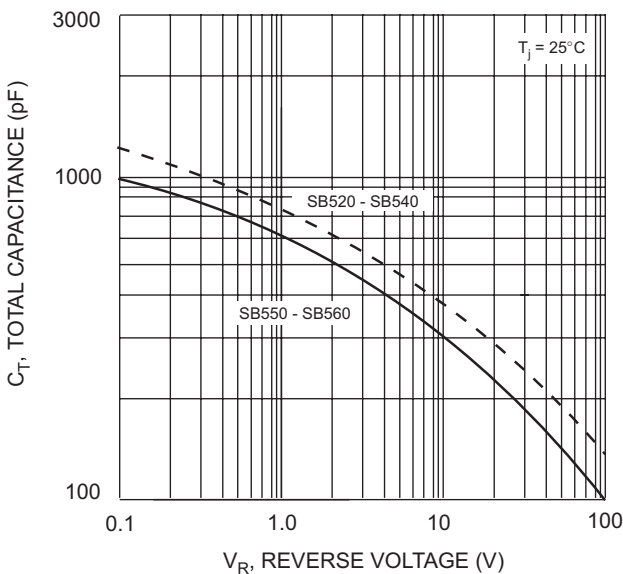


Fig. 5 Typical Total Capacitance

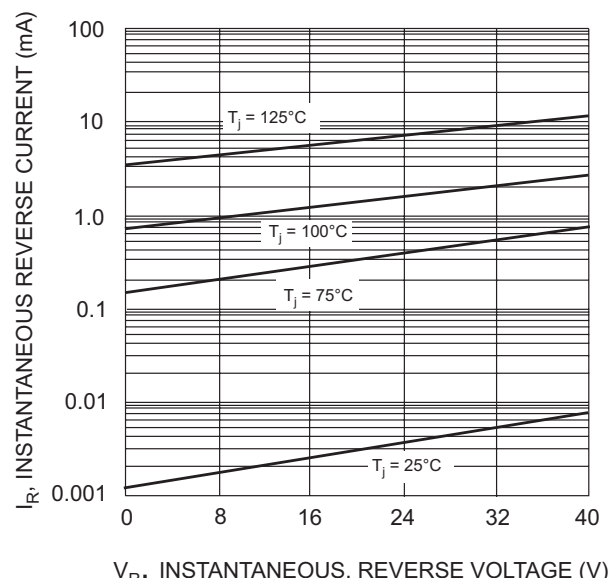


Fig. 6 Typical Reverse Characteristics, SB520 - SB540

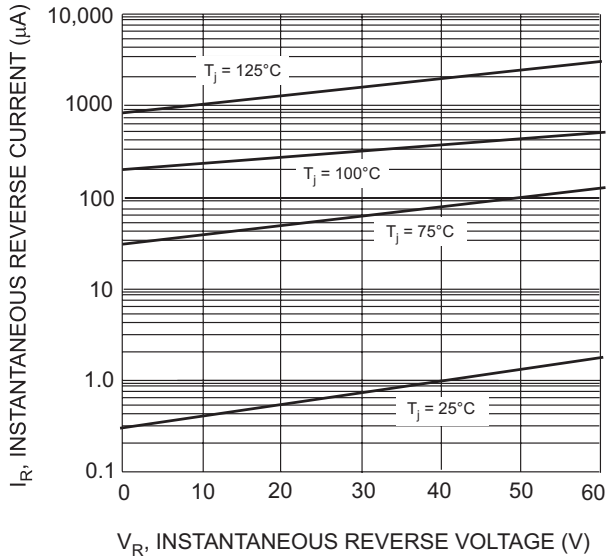


Fig. 7 Typical Reverse Characteristics, SB550 & SB560

Ordering Information (Note 5)

Device	Packaging	Shipping
SB520-A	DO-201AD	1K/Ammo
SB520-B	DO-201AD	500/Bulk
SB520-T	DO-201AD	1.2K/Tape & Reel, 13-inch
SB530-A	DO-201AD	1K/Ammo
SB530-B	DO-201AD	500/Bulk
SB530-T	DO-201AD	1.2K/Tape & Reel, 13-inch
SB540-A	DO-201AD	1K/Ammo
SB540-B	DO-201AD	500/Bulk
SB540-T	DO-201AD	1.2K/Tape & Reel, 13-inch
SB550-A	DO-201AD	1K/Ammo
SB550-B	DO-201AD	500/Bulk
SB550-T	DO-201AD	1.2K/Tape & Reel, 13-inch
SB560-A	DO-201AD	1K/Ammo
SB560-B	DO-201AD	500/Bulk
SB560-T	DO-201AD	1.2K/Tape & Reel, 13-inch

Notes: 5. For packaging details, visit our website at <http://www.diodes.com/datasheets/ap02008.pdf>

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